



## MJ P-Channel Enhancement Mode Power MOSFET

### Description

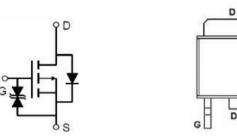
The MJ01P30K uses advanced trench technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

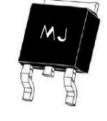
Application

◆ Portable equipment and battery powered systems

#### General Features

- $ightharpoonup V_{DS} = -100 V, I_D = -30 A$   $R_{DS(ON)} < 58 mΩ @ V_{GS} = -10 V (Typ:44 mΩ)$   $R_{DS(ON)} < 65 mΩ @ V_{GS} = -4.5 V (Typ:48 mΩ)$
- Super high dense cell design
- ◆ Advanced trench process technology
- ◆ Reliable and rugged
- ◆ High density celldesign for ultra low on-resistance





Schematic diagram

Marking and pin assignment

TO-252-2L top view

### 100% UIS TESTED! 100% ΔVds TESTED!

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ01P30K	MJ01P30K	TO-252-2L	2	-	9

### Absolute Maximum Ratings (Tc = 25 °Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	-30	А
Drain Current-Continuous(Tc =100°C)	ID(100°C)	-21	А
Pulsed Drain Current	Ірм	-150	А
Maximum Power Dissipation	Po	120	W
Derating factor		0.8	W/°C
Operating Junction and Storage Temperature Range	Тл,Тѕтс	-55 To 175	°C

### Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	1.25	°C/W
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# Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Uni
Off Characteristics						
Drain-Source Breakdown Voltage	BVpss	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-100	-	-	V
Zero Gate Voltage Drain Current	Ipss	Vps=-100V,Vgs=0V	-	-	1	μA
Gate-Body Leakage Current	Igss	V <sub>DS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±10	μA
On Characteristics (Note 3)	'					
Gate Threshold Voltage	VGS(th)	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA	-1.5	-1.9	-2.5	V
Drain-Source On-State Resistance	Prevent	V <sub>GS</sub> =-10V, I <sub>D</sub> =-15A	-	44	58	mΩ
Diam-source On-state Resistance	Rds(on)	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-15A	-	48	65	mΩ
Forward Transconductance	<b>g</b> FS	Vps=-50V,Ip=-10A	5	_	-	S
Dynamic Characteristics (Note 4)	'					
Input Capacitance	Clss		-	3810	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =-50V,V <sub>GS</sub> =0V, F=1.0MHz	-	93	-	PF
Reverse Transfer Capacitance	Crss	-	-	91	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	17	-	nS
Turn-on Rise Time	tr	Vdd=-50V,Id=-15A	-	80	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =-10V,R <sub>GEN</sub> =9.1Ω	-	45	-	nS
Turn-Off Fall Time	tr	_	-	65	-	nS
Total Gate Charge	Qg		_	136	_	nC
Gate-Source Charge	Qgs	V <sub>DS</sub> =-50V,I <sub>D</sub> =-15A V <sub>GS</sub> =-10V	_	22	_	nC
Gate-Drain Charge	Qgd	-	_	26	_	nC
Drain-Source Diode Characteristics		1		l		
Diode Forward Voltage (Note 3)	VsD	V <sub>GS</sub> =0V,I <sub>S</sub> =-10A	-	_	-1.2	V
Diode Forward Current (Note 2)	ls		_	-	-30	А
Reverse Recovery Time	trr	T1=25°C 15= 45A	_	90	_	nS
Reverse Recovery Charge	Qrr	TJ=25°C, IF=-15A di/dt=100A/µs (Note 3)	-	70	_	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is ne	alicib!-#	  rn cn != '	ominat! !	 

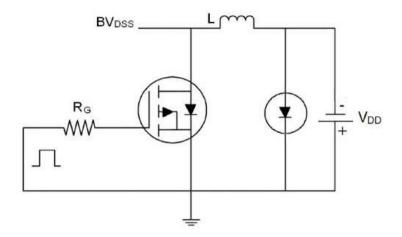
### Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production

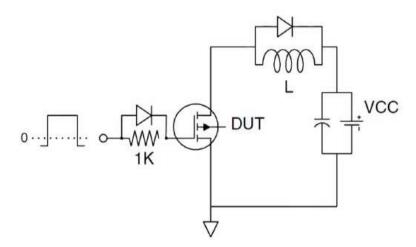




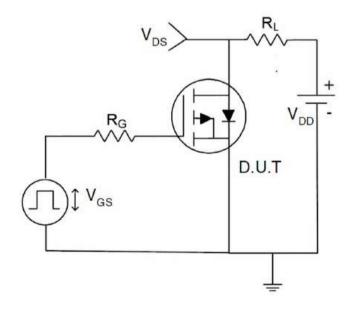
### Test circuit



Eas test Circuit



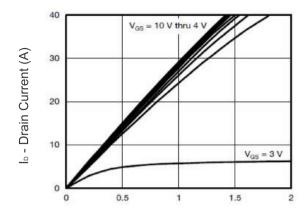
Gate charge test Circuit



Switch Time Test Circuit



### Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V) Figure 1 Output Characteristics

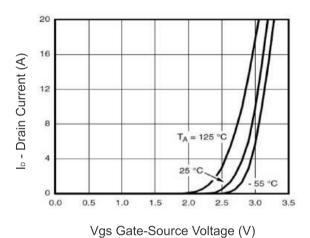


Figure 2 Transfer Characteristics

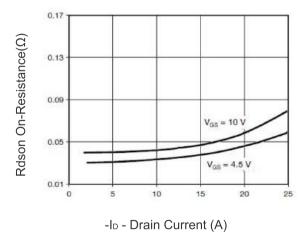
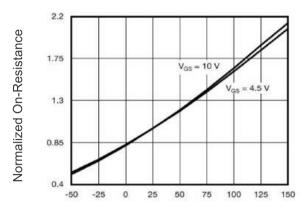
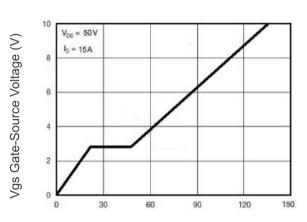


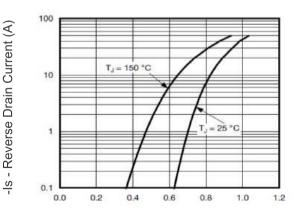
Figure 3 Rdson- Drain Current



T<sub>J</sub> -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature

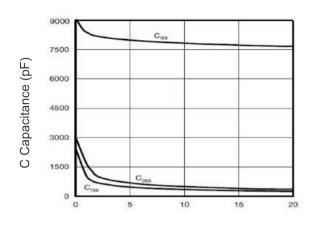


Qg Gate Charge (nC) Figure 5 Gate Charge



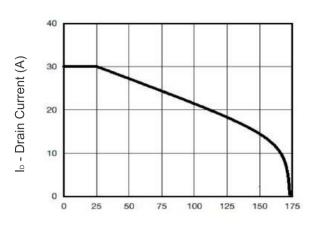
-Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward





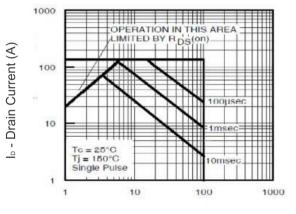
-Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



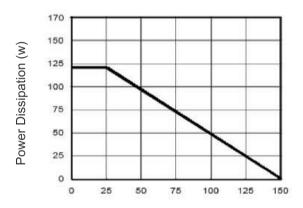
Tc Case Temperature(°C)

Figure 9 Drain Current vs Case Temperature



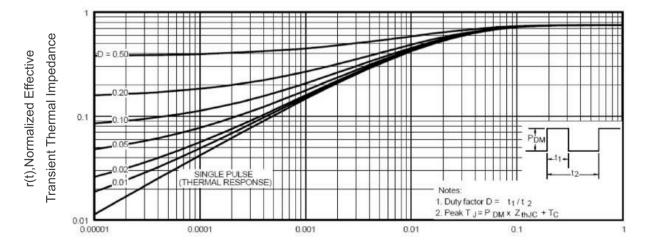
-Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area



T<sub>J</sub> -Junction Temperature(°C)

Figure 10 Power De-rating



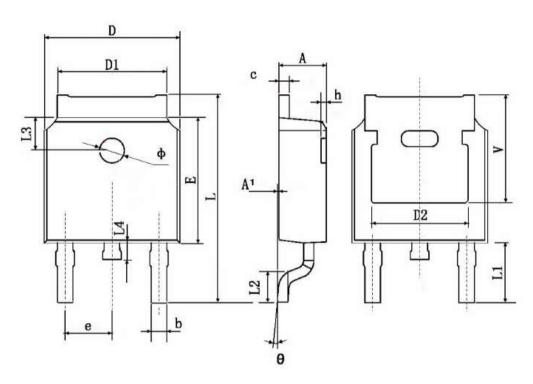
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





# TO-252 Package Information



Symbol	Dimensions	n Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900	2.900 TYP.		TYP.
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0.	8°
h	0.000	0.300	0.000	0.012
V	5.350	5.350 TYP. 0.21		TYP.





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